

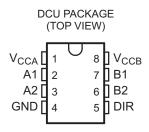
# DUAL-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

Check for Samples: SN74AVC2T45-Q1

## FEATURES

- Qualified for Automotive Applications
- Control Inputs V<sub>IH</sub>/V<sub>IL</sub> Levels Are Referenced to V<sub>CCA</sub> Voltage
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I/Os Are 4.6-V Tolerant
- Ioff Supports Partial-Power-Down Mode
  Operation
- Max Data Rates
  - 500 Mbps (1.8-V to 3.3-V Translation)
  - 320 Mbps (<1.8-V to 3.3-V Translation)
  - 320 Mbps (Translate to 2.5 V or 1.8 V)
  - 280 Mbps (Translate to 1.5 V)
  - 240 Mbps (Translate to 1.2 V)

- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 8000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



## DESCRIPTION

This dual-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVC2T45 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input activate either the B-port outputs or the A-port outputs. The device transmits data from the A bus to the B bus when the B-port outputs are activated and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess  $I_{CC}$  and  $I_{CCZ}$ .

The SN74AVC2T45 is designed so that the DIR input is powered by  $V_{CCA}$ .

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The  $V_{CC}$  isolation feature ensures that if either  $V_{CC}$  input is at GND, both ports are in the high-impedance state.

### **ORDERING INFORMATION**<sup>(1)</sup>

T <sub>A</sub>	PACK	AGE <sup>(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
–40°C to 105°C	VSSOP – DCU	Reel of 3000	CAVC2T45TDCURQ1	SBUI		

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TEXAS INSTRUMENTS

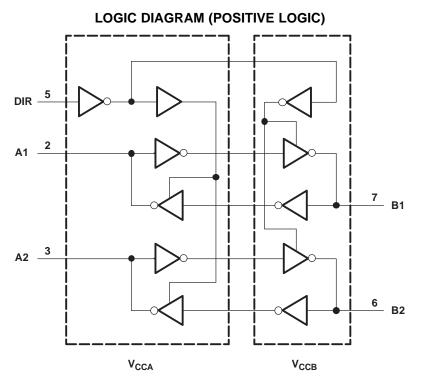
SCES813-JUNE 2010

#### www.ti.com

#### FUNCTION TABLE<sup>(1)</sup> (EACH TRANSCEIVER)

(=/										
INPUT DIR	OPERATION									
L	B data to A bus									
Н	A data to B bus									

(1) Input circuits of the data I/Os always are active.





#### www.ti.com

### ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CCA</sub> V <sub>CCB</sub>	Supply voltage range		-0.5	4.6	V
		I/O ports (A port)	-0.5	4.6	
VI	Input voltage range <sup>(2)</sup>	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
V	Voltage range applied to any output in the high-impedance or	A port	-0.5	4.6	V
Vo	Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup>	B port	-0.5	4.6	V
V	$V_{cltane}$ and $v_{cltane}$ and $v_{cltane}$ (2) (3)	A port	-0.5	V <sub>CCA</sub> + 0.5	V
Vo	Voltage range applied to any output in the high or low state $^{(2)}$ $^{(3)}$	B port	-0.5	V <sub>CCB</sub> + 0.5	V
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
lo	Continuous output current			±50	mA
	Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND			±100	mA
$\theta_{JA}$	Package thermal impedance <sup>(4)</sup>	DCU package		227	°C/W
T <sub>stg</sub>	Storage temperature range	·	-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating" conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current ratings are observed. (2)

(3)

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

# SN74AVC2T45-Q1

SCES813-JUNE 2010

NSTRUMENTS

EXAS

www.ti.com

## **RECOMMENDED OPERATING CONDITIONS**<sup>(1)(2)(3)(4)(5)</sup>

			V <sub>CCI</sub>	V <sub>cco</sub>	MIN	MAX	UNIT
V <sub>CCA</sub>	Supply voltage				1.2	3.6	V
V <sub>CCB</sub>	Supply voltage				1.2	3.6	V
			1.2 V to 1.95 V		$V_{CCI} \times 0.65$		
VIH	High-level input voltage	Data inputs <sup>(4)</sup>	1.95 V to 2.7 V		1.6		V
	input voltage		2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			$V_{CCI} \times 0.35$	
V <sub>IL</sub>	Low-level input voltage	Data inputs <sup>(4)</sup>	1.95 V to 2.7 V			0.7	V
	input voltage		2.7 V to 3.6 V			0.8	
			1.2 V to 1.95 V		V <sub>CCA</sub> × 0.65		
VIH	High-level input voltage	DIR (referenced to V <sub>CCA</sub> ) <sup>(5)</sup>	1.95 V to 2.7 V		1.6		V
	input voltage		2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			$V_{CCA} \times 0.35$	
V <sub>IL</sub>	Low-level input voltage	DIR (referenced to V <sub>CCA</sub> ) <sup>(5)</sup>	1.95 V to 2.7 V			0.7	V
	input voltago		2.7 V to 3.6 V			0.8	
VI	Input voltage				0	3.6	V
V		Active state			0	V <sub>cco</sub>	V
Vo	Output voltage	3-state			0	3.6	v
				1.2 V		-3	
				1.4 V to 1.6 V		-6	
I <sub>OH</sub>	High-level output	current		1.65 V to 1.95 V		-8	mA
				2.3 V to 2.7 V		-9	
				3 V to 3.6 V		-12	
				1.2 V		3	
				1.4 V to 1.6 V		6	
I <sub>OL</sub>	Low-level output of	urrent		1.65 V to 1.95 V		8	mA
				2.3 V to 2.7 V		9	
				3 V to 3.6 V		12	
Δt/Δv	Input transition ris	e or fall rate				5	ns/V
T <sub>A</sub>	Operating free-air	temperature			-40	105	°C

V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.
 V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.
 All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. See the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
 For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCI</sub> × 0.7 V, V<sub>IL</sub> max = V<sub>CCI</sub> × 0.3 V.
 For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCA</sub> × 0.7 V, V<sub>IL</sub> max = V<sub>CCA</sub> × 0.3 V.



#### www.ti.com

## ELECTRICAL CHARACTERISTICS<sup>(1)(2)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONF	ITIONS	v	N		T <sub>A</sub> = 25°C		–40°C to 10	5°C	UNIT
PAR	AMETER	TEST COND		V <sub>CCA</sub>	V <sub>CCB</sub>	MIN	TYP	MAX	MIN	MAX	UNIT
		I <sub>OH</sub> = −100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V				$V_{CCO}$ – 0.2 V		
		I <sub>OH</sub> = -3 mA		1.2 V	1.2 V		0.95				
		I <sub>OH</sub> = -6 mA		1.4 V	1.4 V				1.05		V
V <sub>OH</sub>		I <sub>OH</sub> = -8 mA	$V_{I} = V_{IH}$	1.65 V	1.65 V				1.2		v
		I <sub>OH</sub> = -9 mA		2.3 V	2.3 V				1.75		
		I <sub>OH</sub> = -12 mA		3 V	3 V				2.3		
		I <sub>OL</sub> = 100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V					0.2	
		I <sub>OL</sub> = 3 mA		1.2 V	1.2 V		0.25				
		I <sub>OL</sub> = 6 mA		1.4 V	1.4 V					0.35	V
V <sub>OL</sub>		I <sub>OL</sub> = 8 mA	$V_{I} = V_{IL}$	1.65 V	1.65 V					0.45	v
		I <sub>OL</sub> = 9 mA		2.3 V	2.3 V					0.55	
		I <sub>OL</sub> = 12 mA		3 V	3 V					0.7	
I <sub>I</sub>	DIR	V <sub>I</sub> = V <sub>CCA</sub> or GND		1.2 V to 3.6 V	1.2 V to 3.6 V		±0.025	±0.25		±1	μA
	A port			0 V	0 to 3.6 V		±0.1	±1		±5	٨
I <sub>off</sub>	B port	$V_{\rm I}$ or $V_{\rm O} = 0$ to 3	3.6 V	0 to 3.6 V	0 V		±0.1	±1		±5	μA
	B port	$V_{O} = V_{CCO}$ or G	ND,	0 V	3.6 V		±0.5	±2.5		±5	٨
l <sub>oz</sub>	A port	$V_{I} = V_{CCI}$ or GN		3.6 V	0 V		±0.5	±2.5		±5	μA
				1.2 V to 3.6 V	1.2 V to 3.6 V					10	
I <sub>CCA</sub>		$V_I = V_{CCI}$ or GN	D, I <sub>O</sub> = 0	0 V	3.6 V					-2	μA
				3.6 V	0 V					10	
				1.2 V to 3.6 V	1.2 V to 3.6 V					10	
I <sub>CCB</sub>		$V_I = V_{CCI}$ or GN	D, I <sub>O</sub> = 0	0 V	3.6 V					10	μA
				3.6 V	0 V					-2	
I <sub>CCA</sub> - (see	⊦ I <sub>CCB</sub> Table 1)	$V_{I} = V_{CCI}$ or GN	D, I <sub>O</sub> = 0	1.2 V to 3.6 V	1.2 V to 3.6 V					20	μΑ
CI	Control inputs	V <sub>I</sub> = 3.3 V or GN	ND	3.3 V	3.3 V		2.5				pF
C <sub>io</sub>	A or B port	$V_{O} = 3.3 \text{ V or G}$	ND	3.3 V	3.3 V		6				pF

 $\begin{array}{ll} \mbox{(1)} & V_{CCO} \mbox{ is the } V_{CC} \mbox{ associated with the output port.} \\ \mbox{(2)} & V_{CCI} \mbox{ is the } V_{CC} \mbox{ associated with the input port.} \end{array}$ 

SCES813-JUNE 2010

## SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 1.2 \text{ V}$  (see Figure 1)

PARAMETER	FROM	то	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = 1.5 V	V <sub>CCB</sub> = 1.8 V	V <sub>CCB</sub> = 2.5 V	V <sub>CCB</sub> = 3.3 V	UNIT
PARAMETER	(INPUT)	(OUTPUT)	ТҮР	ТҮР	ТҮР	ТҮР	TYP	UNIT
t <sub>PLH</sub>	٨	P	3.1	2.6	2.4	2.2	2.2	
t <sub>PHL</sub>	A	В	3.1	2.6	2.4	2.2	2.2	ns
t <sub>PLH</sub>	В		3.4	3.1	3	2.9	2.9	
t <sub>PHL</sub>	В	A	3.4	3.1	3	2.9	2.9	ns
t <sub>PHZ</sub>	DID		5.2	5.2	5.1	5	4.8	
t <sub>PLZ</sub>	DIR	A	5.2	5.2	5.1	5	4.8	ns
t <sub>PHZ</sub>	DID	P	5	4	3.8	2.8	3.2	
t <sub>PLZ</sub>	DIR	В	5	4	3.8	2.8	3.2	ns
t <sub>PZH</sub> <sup>(1)</sup>	DID		8.4	7.1	6.8	5.7	6.1	
t <sub>PZL</sub> <sup>(1)</sup>	DIR	A	8.4	7.1	6.8	5.7	6.1	ns
t <sub>PZH</sub> <sup>(1)</sup>	DID	<b>_</b>	8.3	7.8	7.5	7.2	7	
t <sub>PZL</sub> <sup>(1)</sup>	DIR	В	8.3	7.8	7.5	7.2	7	ns

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.

## SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$  (see Figure 1)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1	1.5 V I V	V <sub>ССВ</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = 3.3 V ± 0.3 V		UNIT
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	А	В	2.8	0.7	5.6	0.5	4.8	0.4	3.9	0.3	3.7	~~~
t <sub>PHL</sub>	A	Б	2.8	0.7	5.6	0.5	4.8	0.4	3.9	0.3	3.7	ns
t <sub>PLH</sub>	В	А	2.7	0.8	5.6	0.7	5.4	0.6	5.1	0.5	4.9	20
t <sub>PHL</sub>	Б	A	2.7	0.8	5.6	0.7	5.4	0.6	5.1	0.5	4.9	ns
t <sub>PHZ</sub>	DIR	А	3.9	1.3	8.7	1.3	8	1.1	7.9	1.4	7.8	~~~
t <sub>PLZ</sub>	DIR	A	3.9	1.3	8.7	1.3	8	1.1	7.9	1.4	7.8	ns
t <sub>PHZ</sub>	DIR	В	4.7	1.1	7.2	1.4	7.1	1.2	7.1	1.7	7.3	~~~
t <sub>PLZ</sub>	DIR	Б	4.7	1.1	7.2	1.4	7.1	1.2	7.1	1.7	7.3	ns
t <sub>PZH</sub> <sup>(1)</sup>	DID	•	7.4		12.6		12.3		12		12	
t <sub>PZL</sub> <sup>(1)</sup>	DIR	A	7.4		12.6		12.3		12		12	ns
t <sub>PZH</sub> <sup>(1)</sup>	סוס	В	6.7		14.1		12.6		11.6		11.3	~~
t <sub>PZL</sub> <sup>(1)</sup>	DIR	В	6.7		14.1		12.6		11.6		11.3	ns

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.



www.ti.com

### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$  (see Figure 1)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1		V <sub>ССВ</sub> = ± 0.1		V <sub>ССВ</sub> = ± 0.2		V <sub>CCB</sub> = 3.3 V ± 0.3 V		UNIT
	(INPUT)	(OUTPUT)	ТҮР	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	А	В	2.7	0.5	5.4	0.4	4.5	0.2	3.6	0.2	3.3	
t <sub>PHL</sub>	A	Б	2.7	0.5	5.4	0.4	4.5	0.2	3.6	0.2	3.3	ns
t <sub>PLH</sub>	В	^	2.4	0.7	4.9	0.5	4.6	0.5	4.2	0.4	4	
t <sub>PHL</sub>	D	A	2.4	0.7	4.9	0.5	4.6	0.5	4.2	0.4	4	ns
t <sub>PHZ</sub>	DIR	^	3.7	1.3	8.3	0.7	7.1	1.4	5.5	1.1	5.4	
t <sub>PLZ</sub>	DIR	A	3.7	1.3	8.3	0.7	7.1	1.4	5.5	1.1	5.4	ns
t <sub>PHZ</sub>	DID	В	4.4	1.3	6	1.3	6.1	0.8	5.9	1.5	6.1	
t <sub>PLZ</sub>	DIR	В	4.4	1.3	6	1.3	6.1	0.8	5.9	1.5	6.1	ns
t <sub>PZH</sub> <sup>(1)</sup>	DID		6.8		10.7		10.5		9.9		9.9	
t <sub>PZL</sub> <sup>(1)</sup>	DIR	A	6.8		10.7		10.5		9.9		9.9	ns
t <sub>PZH</sub> <sup>(1)</sup>		P	6.4		13.5		11.4		8.9		8.5	
t <sub>PZL</sub> <sup>(1)</sup>	DIR	В	6.4		13.5		11.4		8.9		8.5	ns

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.

### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (see Figure 1)

PARAMETER	FROM (INPUT)	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = 3.3 V ± 0.3 V		UNIT																
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX																	
t <sub>PLH</sub>	А	В	2.6	0.4	5.1	0.2	4.2	0.2	3.2	0.2	2.8	20																
t <sub>PHL</sub>	A	Б	2.6	0.4	5.1	0.2	4.2	0.2	3.2	0.2	2.8	ns																
t <sub>PLH</sub>	В	А	2.1	0.6	4	0.5	3.6	0.4	3.2	0.3	3	20																
t <sub>PHL</sub>	Б	A	2.1	0.6	4	0.5	3.6	0.4	3.2	0.3	3	ns																
t <sub>PHZ</sub>	DIR	А	2.4	0.7	8.1	0.8	6.6	0.8	5.2	0.5	4.5	5																
t <sub>PLZ</sub>	DIR	A	2.4	0.7	8.1	0.8	6.6	0.8	5.2	0.5	4.5	ns																
t <sub>PHZ</sub>	DIR	В	3.8	1	4.5	0.6	4.5	0.5	4.4	1.1	4.3	20																
t <sub>PLZ</sub>	DIR	D	3.8	1	4.5	0.6	4.5	0.5	4.4	1.1	4.3	ns																
t <sub>PZH</sub> <sup>(1)</sup>	DID	•	5.9		8.7		7.9		7.4		7.1																	
t <sub>PZL</sub> <sup>(1)</sup>	DIR	A	5.9		8.7		7.9		7.4		7.1	ns																
t <sub>PZH</sub> <sup>(1)</sup>	חוח	Р	5		13		10.6		8.2		7.1	20																
t <sub>PZL</sub> <sup>(1)</sup>	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	В	5		13		10.6		8.2		7.1	ns

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.

#### SCES813-JUNE 2010

## SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V<sub>CCA</sub> = 3.3 V  $\pm$  0.3 V (see Figure 1)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1		V <sub>ССВ</sub> = ± 0.1				V <sub>CCB</sub> = 3.3 V ± 0.3 V		UNIT
	(INPUT)	(OUTPUT)	ТҮР	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	А	В	2.5	0.3	4.9	0.2	4	0.2	3	0.2	2.6	
t <sub>PHL</sub>	А	В	2.5	0.3	4.9	0.2	4	0.2	3	0.2	2.6	ns
t <sub>PLH</sub>	в	•	2.1	0.6	3.8	0.4	3.3	0.3	2.8	0.3	2.6	
t <sub>PHL</sub>	D	A	2.1	0.6	3.8	0.4	3.3	0.3	2.8	0.3	2.6	ns
t <sub>PHZ</sub>	DIR	^	2.9	1.1	8.2	1	6.7	1.3	4.9	1.2	4.2	20
t <sub>PLZ</sub>	DIK	A	2.9	1.1	8.2	1	6.7	1.3	4.9	1.2	4.2	ns
t <sub>PHZ</sub>		В	3.4	0.5	6.8	0.3	5.8	0.3	4.8	1.1	4.4	
t <sub>PLZ</sub>	DIR	Б	3.4	0.5	6.8	0.3	5.8	0.3	4.8	1.1	4.4	ns
t <sub>PZH</sub> <sup>(1)</sup>	חוח	•	5.5		10.4		8.9		7.4		6.8	
t <sub>PZL</sub> <sup>(1)</sup>	DIR	A	5.5		10.4		8.9		7.4		6.8	ns
t <sub>PZH</sub> <sup>(1)</sup>	DIR		5.4		12.9		10.5		7.7		6.6	
t <sub>PZL</sub> <sup>(1)</sup>		DIR	В	5.4		12.9		10.5		7.7		6.6

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.

# **OPERATING CHARACTERISTICS**

 $T_A = 25^{\circ}C$ 

P	ARAMETER	TEST CONDITIONS	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.2 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.5 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.8 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 2.5 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V	UNIT
		CONDITIONS	TYP	TYP	TYP	TYP	TYP	
<b>c</b> (1)	A-port input, B-port output	$C_{L} = 0,$	3	3	3	3	4	۶L
C <sub>pdA</sub> <sup>(1)</sup>	B-port input, A-port output	f = 10  MHz, $t_r = t_f = 1 \text{ ns}$	12	13	13	14	15	pF
<b>C</b> (1)	A-port input, B-port output	C <sub>L</sub> = 0, f = 10 MHz,	12	13	13	14	15	pF
C <sub>pdB</sub> <sup>(1)</sup>	B-port input, A-port output	$t_r = t_f = 1 \text{ ns}$	3	3	3	3	4	μr

(1) Power-dissipation capacitance per transceiver



#### **Power-Up Considerations**

A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies. To guard against such power-up problems, take the following precautions:

- 1. Connect ground before any supply voltage is applied.
- 2. Power up  $V_{CCA}$ .
- 3.  $V_{CCB}$  can be ramped up along with or after  $V_{CCA}$ .

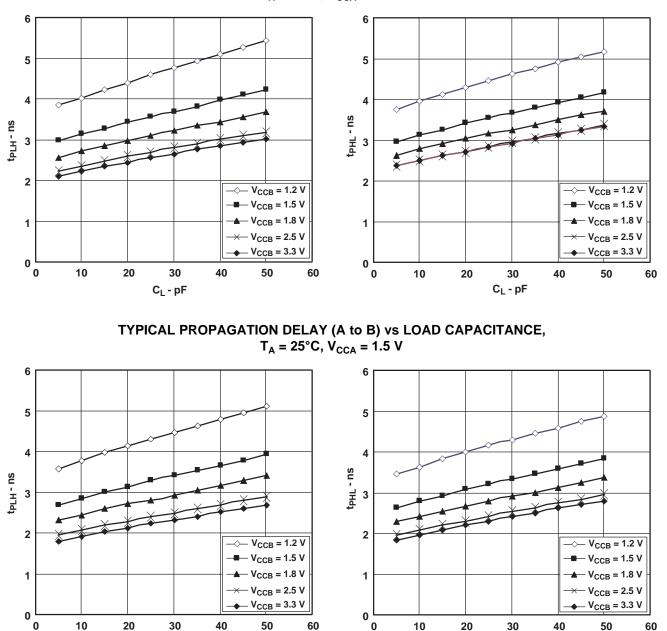
V			٧ <sub>c</sub>	CA			UNIT
V <sub>CCB</sub>	0 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	UNIT
0 V	0	<0.5	<0.5	<0.5	<0.5	<0.5	
1.2 V	<0.5	<1	<1	<1	<1	1	-
1.5 V	<0.5	<1	<1	<1	<1	1	
1.8 V	<0.5	<1	<1	<1	<1	<1	μΑ
2.5 V	<0.5	1	<1	<1	<1	<1	
3.3 V	<0.5	1	<1	<1	<1	<1	

#### Table 1. Typical Total Static Power Consumption (I<sub>CCA</sub> + I<sub>CCB</sub>)



SCES813-JUNE 2010

## **TYPICAL CHARACTERISTICS**



TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE,  $T_A = 25^{\circ}C, V_{CCA} = 1.2 V$ 

C<sub>L</sub> - pF

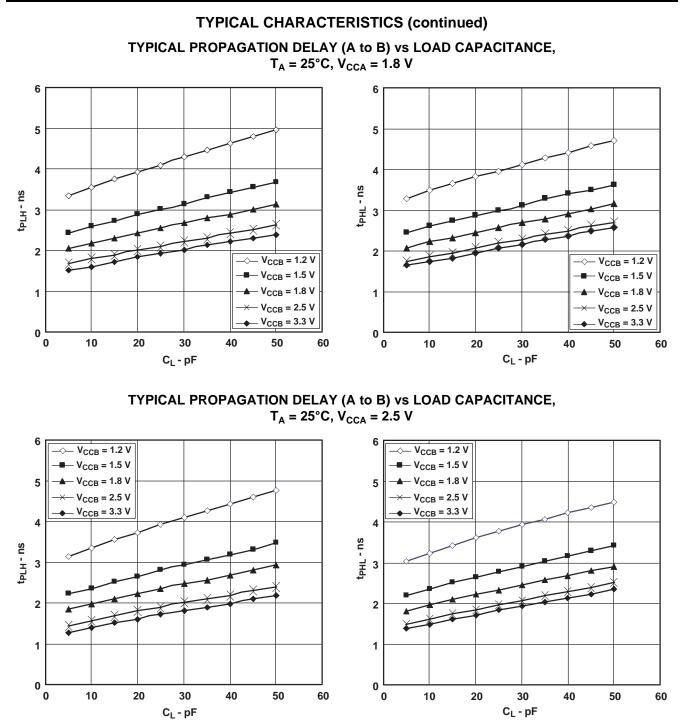
C<sub>L</sub> - pF

60



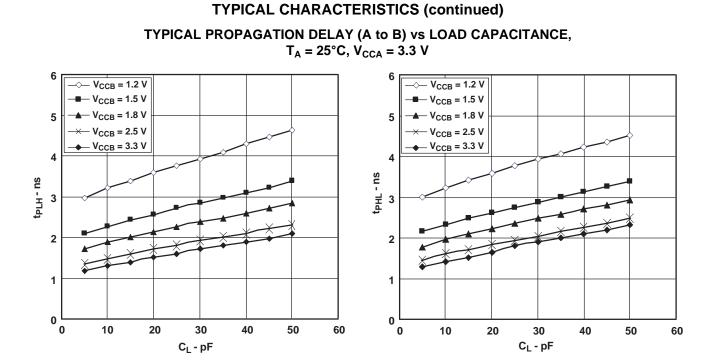








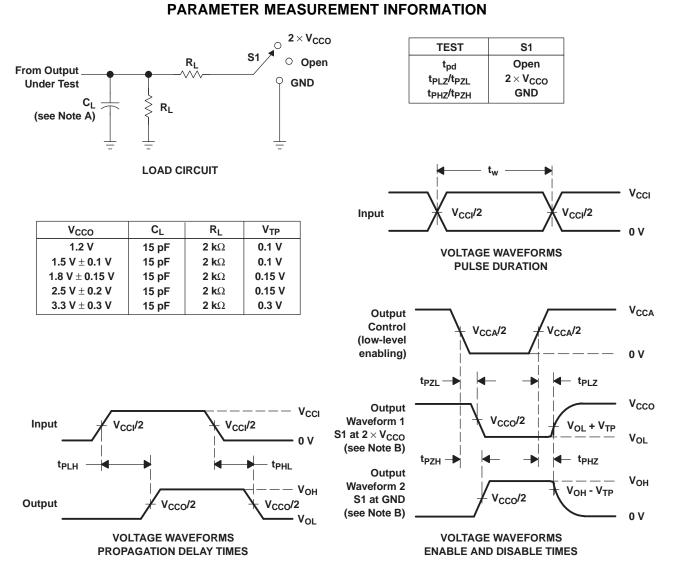
SCES813-JUNE 2010





# SN74AVC2T45-Q1

SCES813-JUNE 2010



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>0</sub> = 50  $\Omega$ , dv/dt  $\geq$  1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
- I. V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.

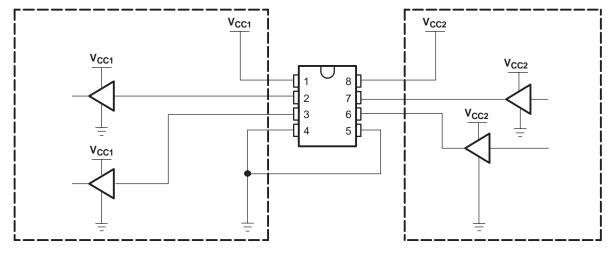
### Figure 1. Load Circuit and Voltage Waveforms



SCES813-JUNE 2010

## **APPLICATION INFORMATION**

Figure 2 is an example circuit of the SN74AVC2T45 used in a unidirectional logic level-shifting application.



SYSTEM-1

SYSTEM-2

PIN	NAME	FUNCTION	DESCRIPTION					
1	V <sub>CCA</sub>	V <sub>CC1</sub>	SYSTEM-1 supply voltage (1.2 V to 3.6 V)					
2	A1	OUT1	Output level depends on V <sub>CC1</sub> voltage.					
3	A2	OUT2	Output level depends on V <sub>CC1</sub> voltage.					
4	GND	GND	Device GND					
5	DIR	DIR	The GND (low-level) determines B-port to A-port direction.					
6	B2	IN2	Input threshold value depends on V <sub>CC2</sub> voltage.					
7	B1	IN1	Input threshold value depends on V <sub>CC2</sub> voltage.					
8	V <sub>CCB</sub>	V <sub>CC2</sub>	SYSTEM-2 supply voltage (1.2 V to 3.6 V)					

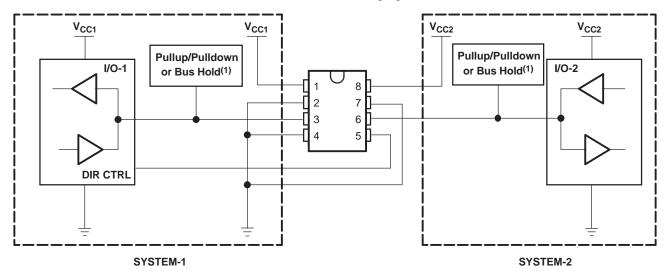
#### Figure 2. Unidirectional Logic Level-Shifting Application



www.ti.com

### **APPLICATION INFORMATION**

Figure 3 shows the SN74AVC2T45 used in a bidirectional logic level-shifting application. Since the SN74AVC2T45 does not have an output-enable (OE) pin, the system designer should take precautions to avoid bus contention between SYSTEM-1 and SYSTEM-2 when changing directions.



Following is a sequence that illustrates data transmission from SYSTEM-1 to SYSTEM-2 and then from SYSTEM-2 to SYSTEM-1.

STATE	DIR CTRL	I/O-1	I/O-2	DESCRIPTION
1	н	Out	In	SYSTEM-1 data to SYSTEM-2
2	н	Hi-Z	Hi-Z	SYSTEM-2 is getting ready to send data to SYSTEM-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on pullup or pulldown. <sup>(1)</sup>
3	L	Hi-Z	Hi-Z	DIR bit is flipped. I/O-1 and I/O-2 still are disabled. The bus-line state depends on pullup or pulldown. <sup>(1)</sup>
4	L	In	Out	SYSTEM-2 data to SYSTEM-1

(1) SYSTEM-1 and SYSTEM-2 must use the same conditions, i.e., both pullup or both pulldown.

#### Figure 3. Bidirectional Logic Level-Shifting Application

#### Enable Times

Calculate the enable times for the SN74AVC2T45 using the following formulas:

- $t_{PZH}$  (DIR to A) =  $t_{PLZ}$  (DIR to B) +  $t_{PLH}$  (B to A)
- $t_{PZL}$  (DIR to A) =  $t_{PHZ}$  (DIR to B) +  $t_{PHL}$  (B to A)
- $t_{P7H}$  (DIR to B) =  $t_{PL7}$  (DIR to A) +  $t_{PLH}$  (A to B)
- $t_{PZL}$  (DIR to B) =  $t_{PHZ}$  (DIR to A) +  $t_{PHL}$  (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74AVC2T45 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.



10-Dec-2020

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
CAVC2T45TDCURQ1	ACTIVE	VSSOP	DCU	8	3000	RoHS & Green	(6) NIPDAU	Level-1-260C-UNLIM	-40 to 125	SBUI	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(<sup>6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN74AVC2T45-Q1 :



# PACKAGE OPTION ADDENDUM

10-Dec-2020

• Catalog: SN74AVC2T45

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

# PACKAGE MATERIALS INFORMATION

w

(mm)

8.0

4.0

Pin1

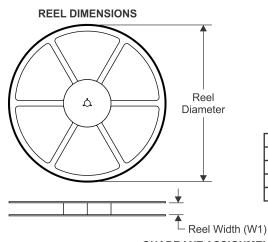
Quadrant

Q3

www.ti.com

Texas Instruments

## **TAPE AND REEL INFORMATION**



VSSOP

DCU

CAVC2T45TDCURQ1



## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



180.0

8.4

2.25

3.35

1.05

*All dimensions are nominal									
Device	Package Type	Package Drawing	SPQ	Reel Diameter	Reel Width	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)
	.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	Drannig			W1 (mm)		()	()	()

3000

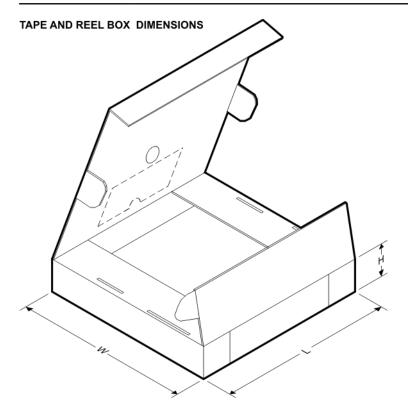
8

TEXAS INSTRUMENTS

www.ti.com

# PACKAGE MATERIALS INFORMATION

3-Aug-2017



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CAVC2T45TDCURQ1	VSSOP	DCU	8	3000	202.0	201.0	28.0

DCU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.

D. Falls within JEDEC MO-187 variation CA.





- NOTES: A. All linear dimensions are in millimeters. В. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



#### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2020, Texas Instruments Incorporated